Innovative Service Around the Globe YAGEO

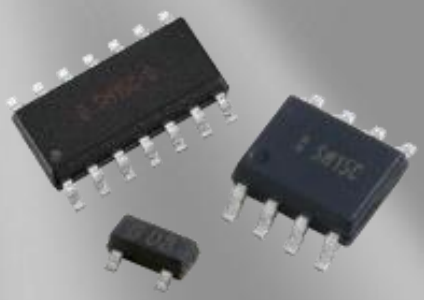
DATA SHEET

ELECTROSTATIC DISCHARGE PROTECTION DEVICES

INDUSTRIAL / CONSUMER

UFS08C2.8L04

RoHS compliant & Halogen free



Product specification– July 04, 2023 V.3

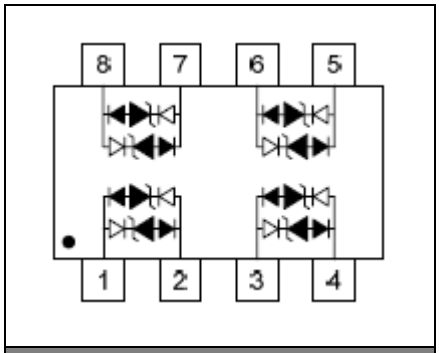
Electrostatic Discharged Protection Devices (ESD) Data Sheet

Description

Brightking's UFS08C2.8L04 component is designed to protect low voltage state-of-the-art CMOS semiconductors from transients caused by electrostatic discharge (ESD), cable discharge events (CDE), lightning and other induced voltage surges. The device provides low stand-off voltages with significant reductions in leakage currents and capacitance over silicon avalanche diode processes.
The UFS08C2.8L04 feature integrated low capacitance compensation diodes that reduce the typical capacitance 5pF per line.
This combined with low leakage current, means signal integrity preserved in high-speed applications such as 10/100/1000 Ethernet.

Features

- IEC61000-4-2 ESD 30KV Air, 30KV contact compliance
- SOIC-08 surface mount package
- Protects four I/O lines
- Peak power dissipation of 600W under 8/20μs waveform
- Working voltage: 2.8V
- Low leakage current
- Low operating and clamping voltages
- Solid-state silicon avalanche technology
- Lead Free/RoHS compliant
- Solder reflow temperature: Pure Tin-Sn, 260~270℃
- Flammability rating UL 94V-0
- Meets MSL level 1, per J-STD-020
- Marking: B SLVU2.8-8



Pin Configuration

Applications

- 10/100/1000 Ethernet
- WAN/LAN Equipment
- High current switching systems
- Desktops, Servers and Notebook
- Instrumentation
- Analog inputs
- Base stations

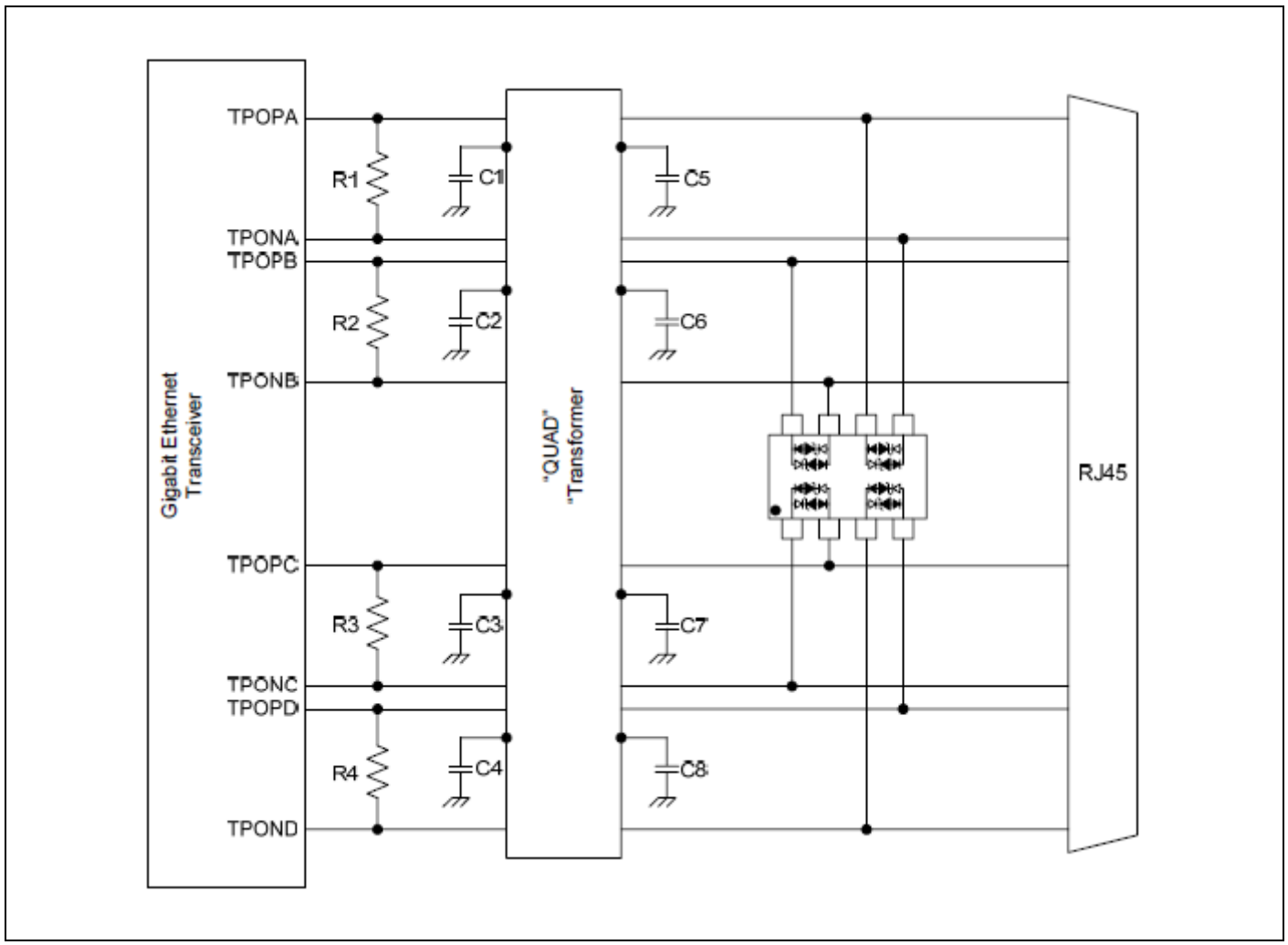
Maximum Ratings

Rating	Symbol	Value	Unit
ESD voltage (Contact discharge)	V_{ESD}	±30	kV
ESD voltage (Air discharge)		±30	
Storage & operating temperature range	T_{STG} ,T_J	-55~+150	℃

Electrical Characteristics (T_J=25℃)

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Reverse stand-off voltage	V_{RWM}				2.8	V
Reverse breakdown voltage	V_{BR}	I_{BR}=1mA	3			V
Reverse leakage current	I_R	V_R=2.8V Each I/O pin			5	μA
Clamping voltage (tp=8/20μs)	V_C	I_{PP}=5A		8.5		V
Peak pulse current (tp=8/20μs)	I_{PP}				24	A
Off state junction capacitance	C_J	0Vdc,f=1MHz Between I/O pins and GND		8		pF

Applications Information



Typical Characteristics Curves

Figure 1. Power Derating Curve

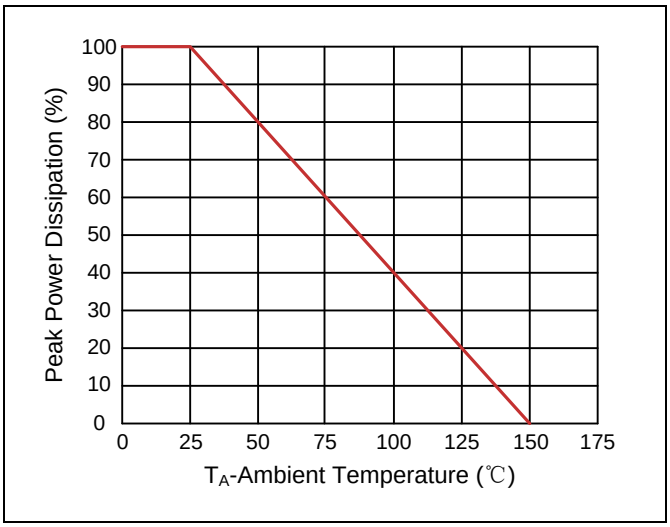


Figure 2. Pulse Waveforms

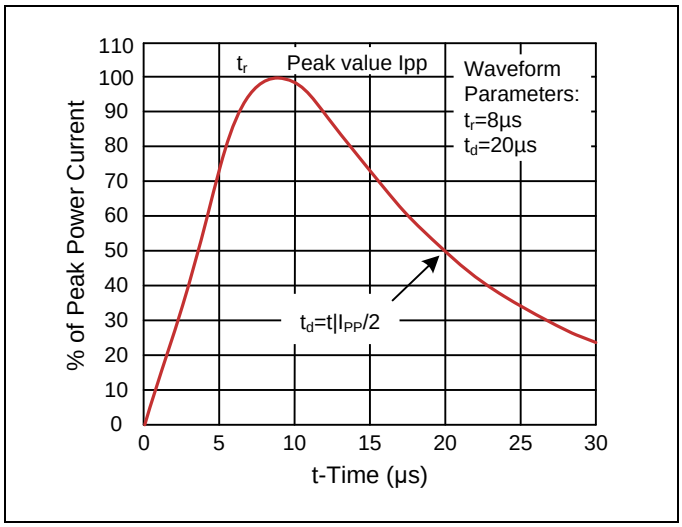


Figure 3. Non-Repetitive Peak Pulse vs. Pulse Time

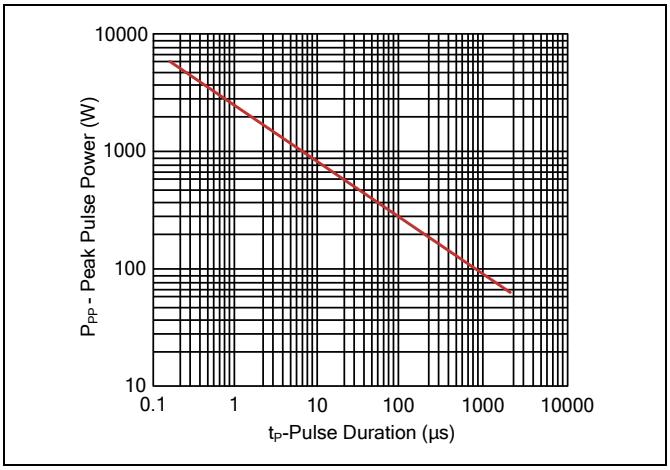


Figure 4. Capacitance vs. Reverse Voltage

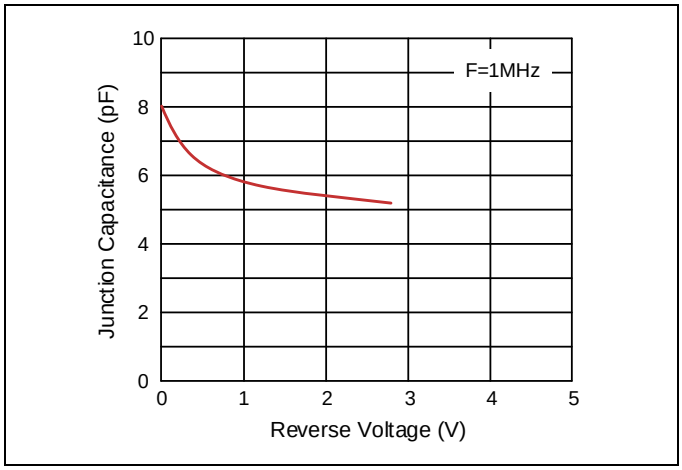
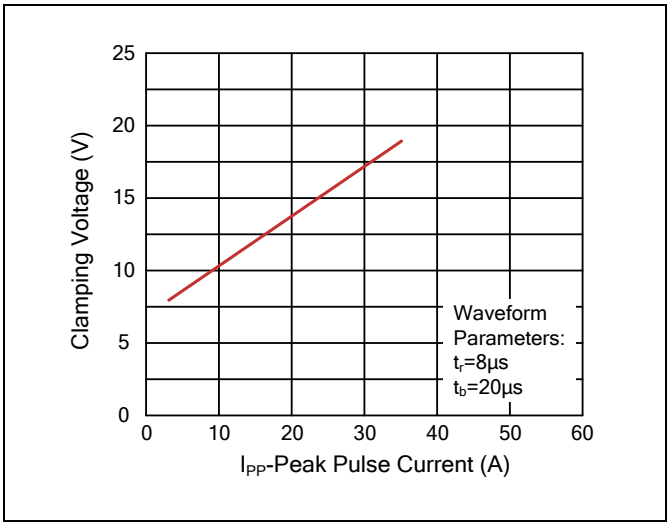
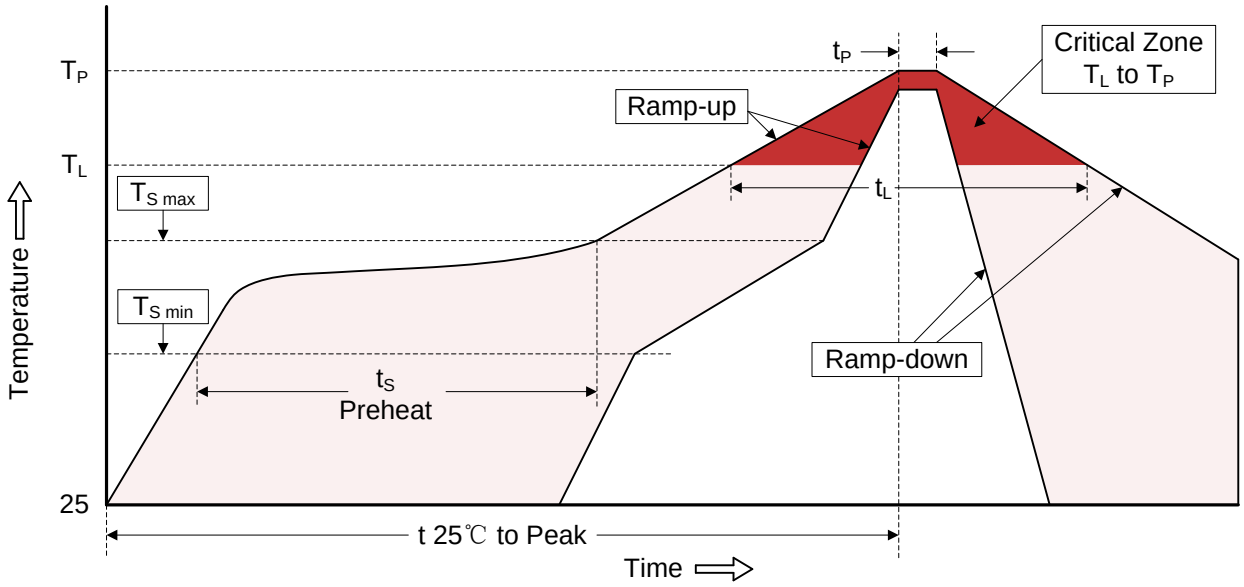


Figure 5. Clamping Voltage vs. Peak Pulse Current



Recommended Soldering Conditions

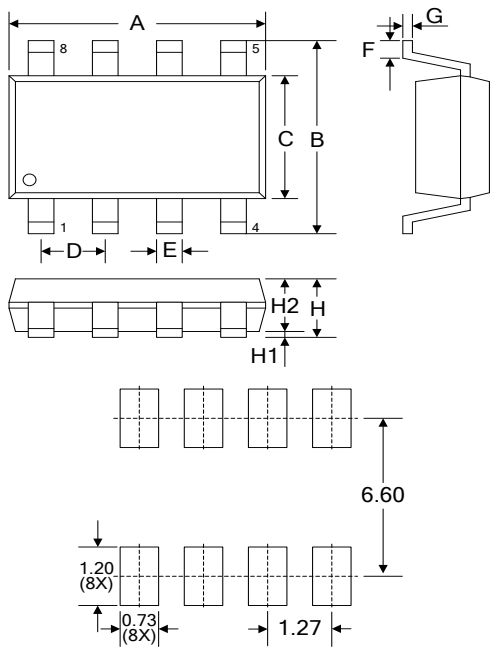
Reflow Soldering



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3℃/second max.
Preheat -Temperature Min ($T_{S\ min}$) -Temperature Max ($T_{S\ max}$) -Time (min to max) (ts)	 150℃ 200℃ 60-180 seconds
$T_{S\ max}$ to T_L -Ramp-up Rate	 3℃/second max.
Time maintained above: -Temperature (T_L) -Time (t_L)	 217℃ 60-150 seconds
Peak Temperature (T_P)	260℃
Time within 5℃ of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6℃/second max.
Time 25℃ to Peak Temperature	8 minutes max.

Dimensions (SOIC-08)

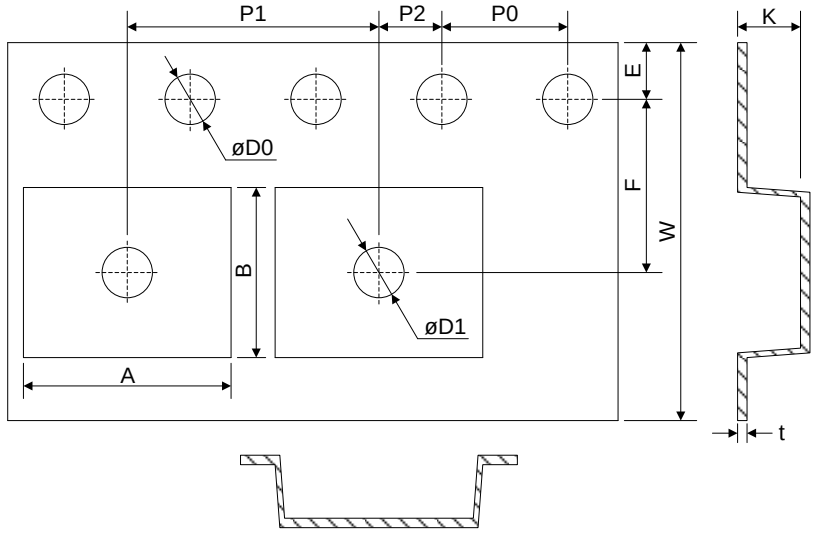


Recommended Soldering Pad Layout

Symbol	Dimension			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.80	5.00	0.189	0.197
B	5.80	6.20	0.228	0.244
C	3.80	4.00	0.150	0.157
D	1.27		0.050	
E	0.33	0.51	0.013	0.020
F	0.40	1.27	0.016	0.050
G	0.19	0.25	0.007	0.010
H	1.35	1.75	0.053	0.069
H1	0.10	0.25	0.004	0.010
H2	1.45		0.057	

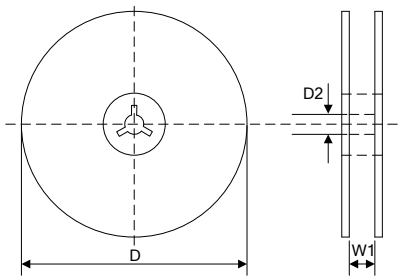
Packaging

Tape



Symbol	Dimension (mm)
W	12.00±0.30
P0	4.00±0.10
P1	8.00±0.10
P2	2.00±0.10
D0	Φ1.55±0.10
D1	Φ1.55±0.05
E	1.75±0.10
F	5.50±0.10
A	6.50±0.10
B	5.40±0.10
K	2.00±0.10
t	0.30±0.05

Reel



D	Φ330.0±3.0
D2	Φ13.0
W1	13.5
Quantity: 2500PCS	

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